

Single P-channel MOSFET

ELM16405EA-S

■ General description

ELM16405EA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■ Features

- $V_{ds} = -30V$
- $I_d = -5A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 52m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 87m\Omega$ ($V_{gs} = -4.5V$)

■ Maximum absolute ratings

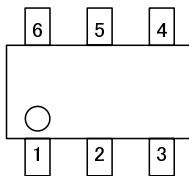
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current	I_d	-5.0	A	1
		-4.2		
Pulsed drain current	I_{dm}	-20	A	2
Power dissipation	P_d	2.0	W	1
		1.4		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	47.5	62.5	°C/W	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	°C/W	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	37.0	50.0	°C/W	3

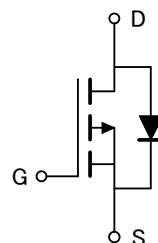
■ Pin configuration

SOT-26 (TOP VIEW)



Pin No.	Pin name
1	DRAIN
2	DRAIN
3	GATE
4	SOURCE
5	DRAIN
6	DRAIN

■ Circuit



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■ Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V	-30			V
Zero gate voltage drain current	Idss	Vds=-24V			-1	μ A
		Vgs=0V	T _j =55°C		-5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μA	-1.0	-1.8	-3.0	V
On state drain current	Id(on)	Vgs=-4.5V, Vds=-5V	-20			A
Static drain-source on-resistance	Rds(on)	Vgs=-10V		39	52	m Ω
		Id=-5A	T _j =125°C	54	70	
		Vgs=-4.5V, Id=-4A		67	87	
Forward transconductance	Gfs	Vds=-5V, Id=-5A	6.0	8.6		S
Diode forward voltage	Vsd	Is=-1A, Vgs=0V		-0.77	-1.00	V
Max. body-diode continuous current	Is				-2.8	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz		700	840	pF
Output capacitance	Coss			120		pF
Reverse transfer capacitance	Crss			75		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		10	15	Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Qg	Vgs=-10V, Vds=-15V Id=-5A		14.7	18.0	nC
Total gate charge (4.5V)	Qg			7.6	9.5	nC
Gate-source charge	Qgs			2.0		nC
Gate-drain charge	Qgd			3.8		nC
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V R _l =3 Ω, R _{gen} =3 Ω		8.3		ns
Turn-on rise time	tr			5.0		ns
Turn-off delay time	td(off)			29.0		ns
Turn-off fall time	tf			14.0		ns
Body diode reverse recovery time	trr	I _f =-5A, dI/dt=100A/μs		23.5	30.0	ns
Body diode reverse recovery charge	Qrr	I _f =-5A, dI/dt=100A/μs		13.4		nC

NOTE :

- The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

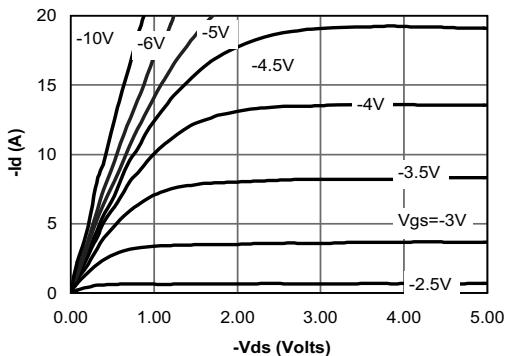


Figure 1: On-Region Characteristics

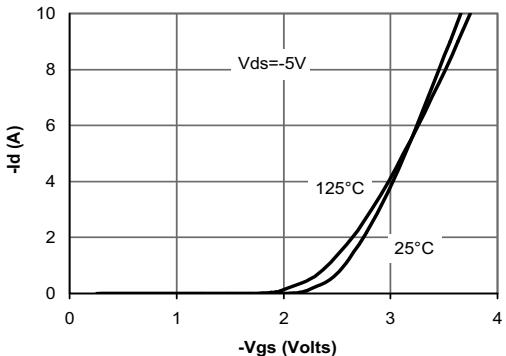


Figure 2: Transfer Characteristics

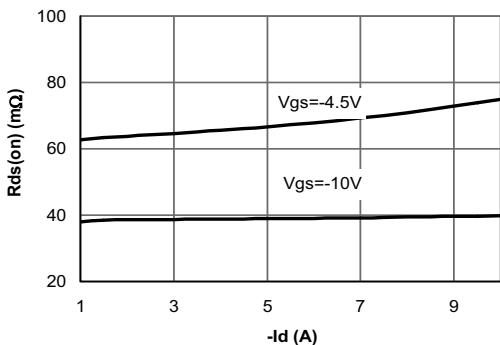


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

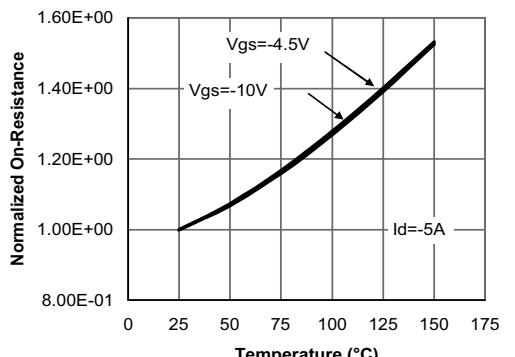


Figure 4: On-Resistance vs. Junction Temperature

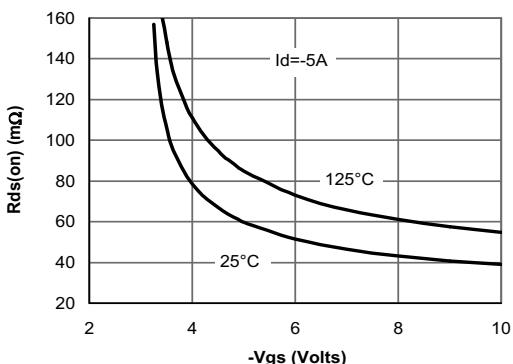


Figure 5: On-Resistance vs. Gate-Source Voltage

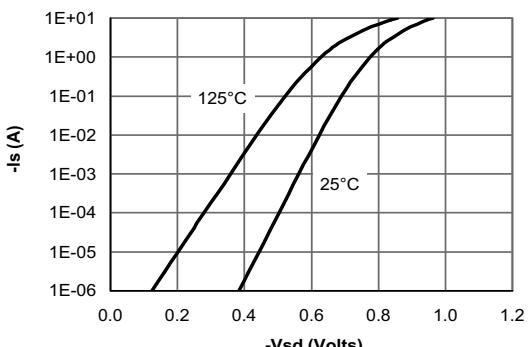


Figure 6: Body-Diode Characteristics

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